

**PHASE CONTROL THYRISTOR**

# AT737

Repetitive voltage up to **2000 V**  
 Mean on-state current **3240 A**  
 Surge current **50.4 kA**

**FINAL SPECIFICATION**

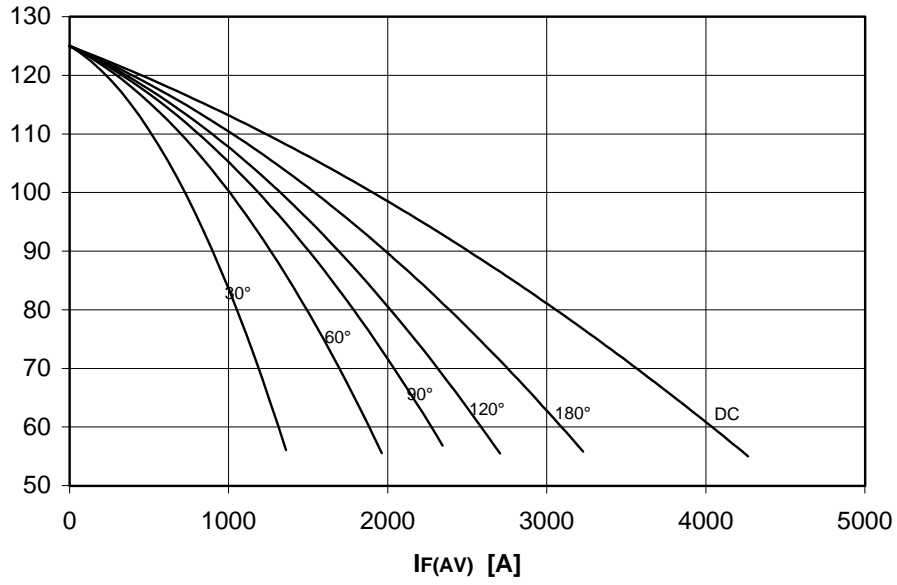
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Symbol	Characteristic	Conditions	T <sub>j</sub> [°C]	Value	Unit
<b>BLOCKING</b>					
V <sub>RRM</sub>	Repetitive peak reverse voltage		125	2000	V
V <sub>RSM</sub>	Non-repetitive peak reverse voltage		125	2100	V
V <sub>DRM</sub>	Repetitive peak off-state voltage		125	2000	V
I <sub>RRM</sub>	Repetitive peak reverse current	V=VRRM	125	200	mA
I <sub>DRM</sub>	Repetitive peak off-state current	V=VDRM	125	200	mA
<b>CONDUCTING</b>					
I <sub>T(AV)</sub>	Mean on-state current	180° sin, 50 Hz, Th=55°C, double side cooled		3240	A
I <sub>T(AV)</sub>	Mean on-state current	180° sin, 50 Hz, Tc=85°C, double side cooled		2545	A
I <sub>TSM</sub>	Surge on-state current	sine wave, 10 ms	125	50.4	kA
I <sup>2</sup> t	I <sup>2</sup> t	without reverse voltage		12701 x1E3	A <sup>2</sup> s
V <sub>T</sub>	On-state voltage	On-state current = 6300 A	25	1.65	V
V <sub>T(TO)</sub>	Threshold voltage		125	0.95	V
r <sub>T</sub>	On-state slope resistance		125	0.127	mohm
<b>SWITCHING</b>					
di/dt	Critical rate of rise of on-state current, min.	From 75% VDRM up to 3550 A, gate 10V 5ohm	125	200	A/μs
dv/dt	Critical rate of rise of off-state voltage, min.	Linear ramp up to 70% of VDRM	125	500	V/μs
t <sub>d</sub>	Gate controlled delay time, typical	VD=100V, gate source 25V, 10 ohm , tr=.5 μs	25	3	μs
t <sub>q</sub>	Circuit commutated turn-off time, typical	dV/dt = 20 V/μs linear up to 75% VDRM		320	μs
Q <sub>rr</sub>	Reverse recovery charge	di/dt=-20 A/μs, I= 2330 A	125		μC
I <sub>rr</sub>	Peak reverse recovery current	VR= 50 V			A
I <sub>H</sub>	Holding current, typical	VD=5V, gate open circuit	25	300	mA
I <sub>L</sub>	Latching current, typical	VD=5V, tp=30μs	25	700	mA
<b>GATE</b>					
V <sub>GT</sub>	Gate trigger voltage	VD=5V	25	3.5	V
I <sub>GT</sub>	Gate trigger current	VD=5V	25	350	mA
V <sub>GD</sub>	Non-trigger gate voltage, min.	VD=VDRM	125	0.25	V
V <sub>FGM</sub>	Peak gate voltage (forward)			30	V
I <sub>FGM</sub>	Peak gate current			10	A
V <sub>RGM</sub>	Peak gate voltage (reverse)			5	V
P <sub>GM</sub>	Peak gate power dissipation	Pulse width 100 μs		150	W
P <sub>G</sub>	Average gate power dissipation			2	W
<b>MOUNTING</b>					
R <sub>th(j-h)</sub>	Thermal impedance, DC	Junction to heatsink, double side cooled		11	°C/kW
R <sub>th(c-h)</sub>	Thermal impedance	Case to heatsink, double side cooled		2	°C/kW
T <sub>j</sub>	Operating junction temperature			-30 / 125	°C
F	Mounting force			40.0 / 50.0	kN
	Mass			1700	g
<b>ORDERING INFORMATION : AT737 S 20</b>					
standard specification <input type="checkbox"/> <input type="checkbox"/> VDRM&VRRM/100					

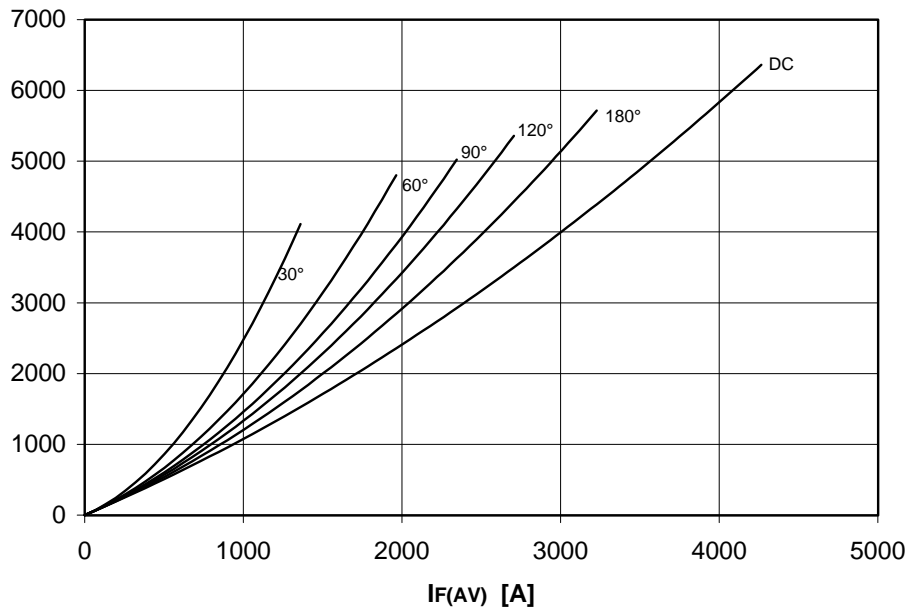
DISSIPATION CHARACTERISTICS

SQUARE WAVE

Th [°C]



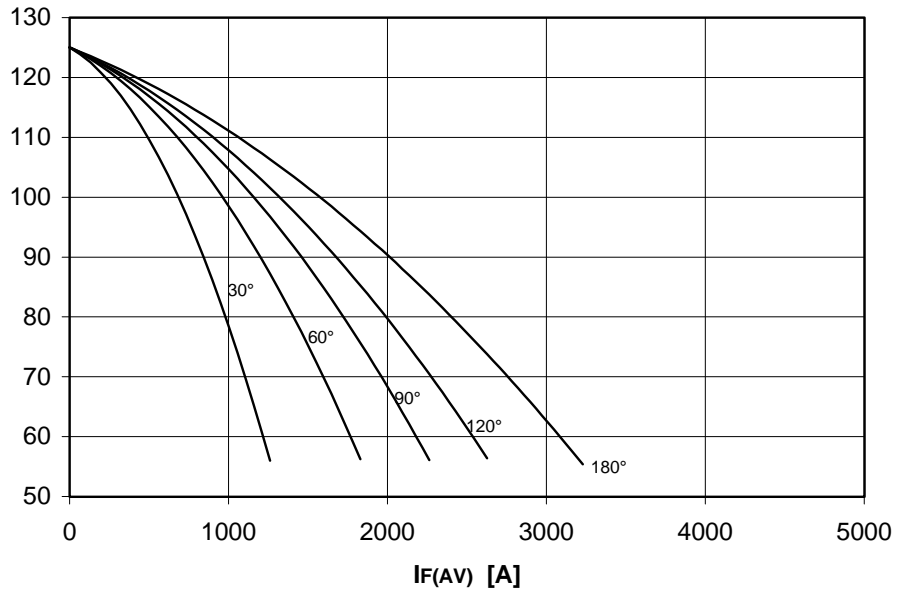
PF(AV) [W]



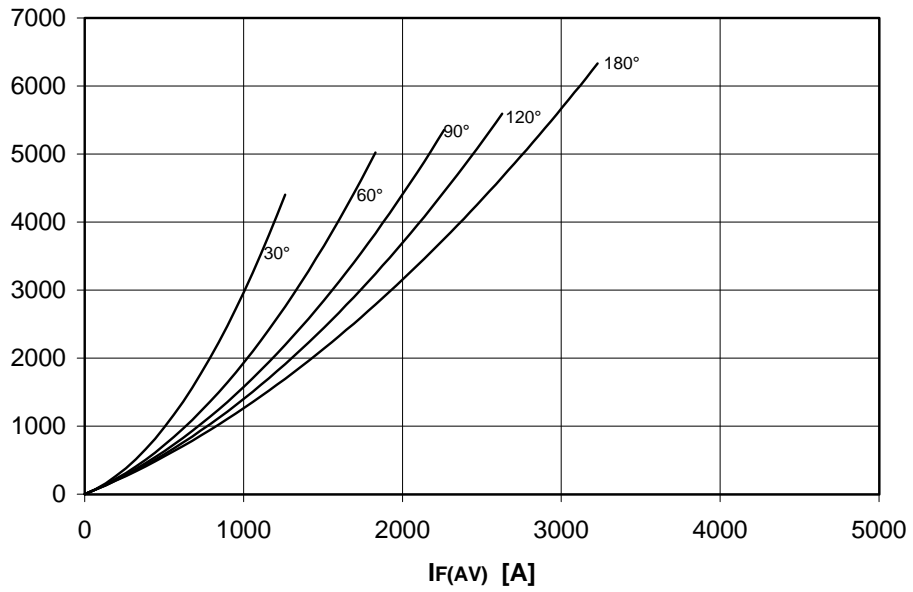
**DISSIPATION CHARACTERISTICS**

SINE WAVE

**Th [°C]**



**PF(AV) [W]**

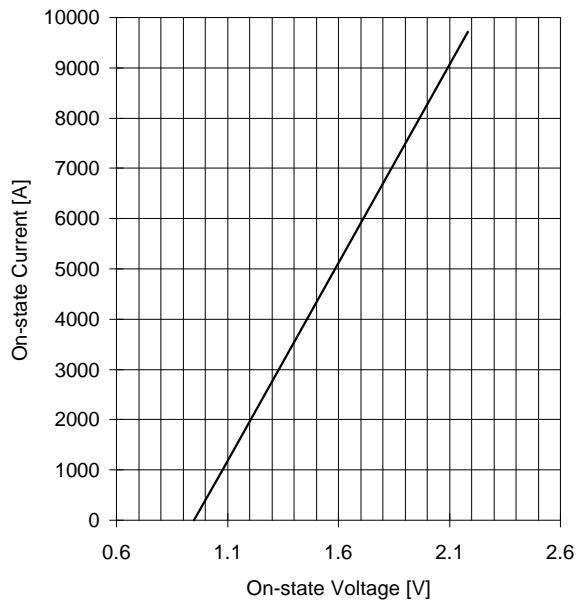


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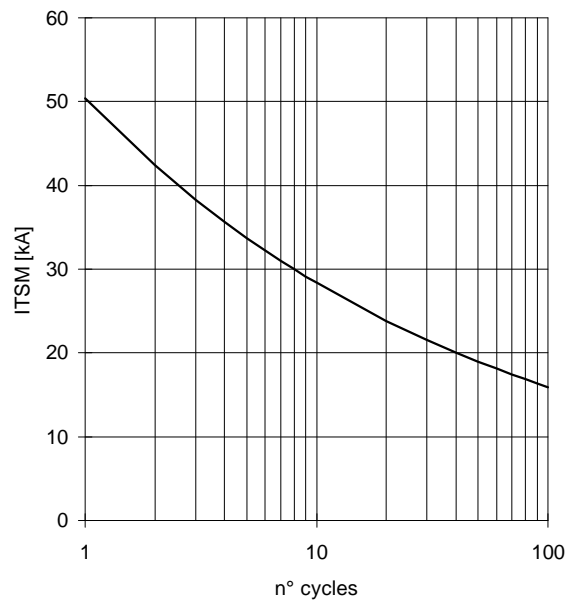
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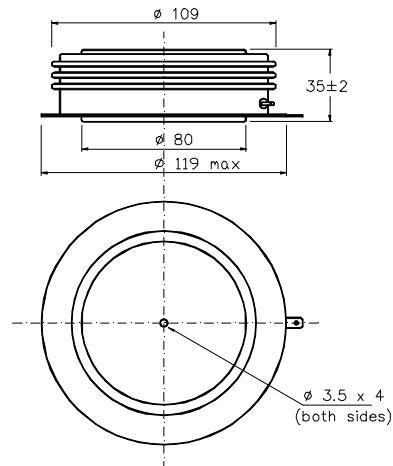
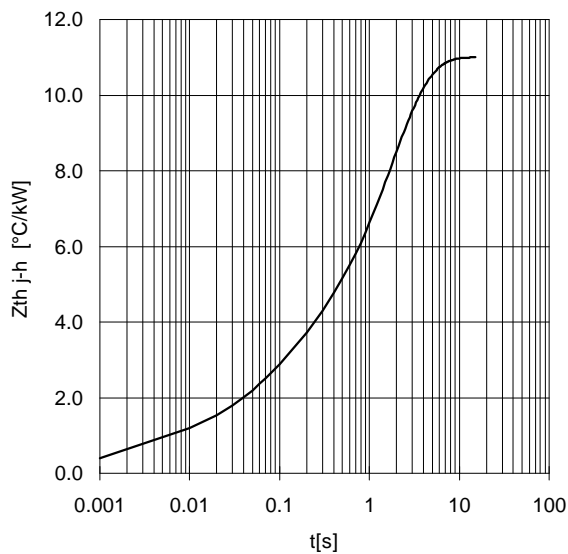
ON-STATE CHARACTERISTIC  
T<sub>j</sub> = 125 °C



SURGE CHARACTERISTIC  
T<sub>j</sub> = 125 °C



TRANSIENT THERMAL IMPEDANCE  
DOUBLE SIDE COOLED



Dimensions  
in mm



Cathode terminal type DIN 46244 - A 4.8 - 0.8

Gate terminal type AMP 60598 - 1

All the characteristics given in this data sheet are guaranteed only with uniform clamping force, cleaned and lubricated heatsink, surfaces with flatness < .03 mm and roughness < 2 μm.

In the interest of product improvement ANSALDO reserves the right to change any data given in this data sheet at any time without previous notice.

If not stated otherwise the maximum value of ratings (symbols over shaded background) and characteristics is reported.

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